

FOAMTEC INTERNATIONAL WCC VALUE ANALYSIS
LAM 2300 METAL ETCH CHAMBER PM

LAM 2300 METAL ETCH CHAMBER PM REQUIREMENTS	FOAMTEC INTL WCC METHOD	STANDARD METHOD
REQUIRED PARTS	(3) Grit Diamond ScrubPAD @ \$25.40/pc = \$76.20 (1) HT4754 UltraSOLV® Sponge @ \$4.87/pc = \$4.87 (25) HT5790S MiraWIPE® @ \$0.70/pc = \$17.50 <u>TOTAL COST = \$98.57/PM</u>	(20) Aluminum Oxide Scrubpads @ \$2.51/pc = \$50.20 (10) Silicon Carbide Scrubpads @ \$4.12/pc = \$41.20 (250+) Alpha Wipes @ \$0.16/pc = \$40.00 <u>TOTAL COST = \$131.40</u>
HAZARDOUS WASTE	(3) ScrubPADS (1) UltraSOLV® Sponge (25) MiraWIPES® (29) TOTAL ITEMS	(30) ScrubPads ScotchBrite (250) LTK Wipers (280) TOTAL ITEMS
PM CLEAN TIME	Total Scrub Time – <u>2.5 Hr</u>	Total Scrub Time – <u>6 Hrs</u>
TECH HOURS	(1) TECHNICIAN	(3) TECHNICIANS
<u>ANALYSIS:</u> (30) LAM 2300 METAL ETCH CHAMBERS METAL ETCH PM EVERY 6Wks (180) LAM METAL ETCH CHAMBER PM/YR	WASTE: (5,220) ITEMS TOOL SCRUBTIME: 450 Hrs TECH HOURS: 450 Hrs	WASTE: (50,400) ITEMS TOOL SCRUBTIME: 1,080 Hrs TECH HOURS: 3,240 Hrs

FOAMTEC INTERNATIONAL WCC VALUE ANALYSIS LAM 2300 METAL ETCH PROCESS CHAMBER PM

Vacuum Chamber: LAM 2300 Metal Etch
Vacuum Chamber Components: Process Chamber
Vacuum Chamber Process Residue: Process Induced Residue

OBJECTIVE:

To demonstrate to how the Foamtec International PM Technique will properly clean the LAM 2300 METAL ETCH chambers more effectively, and in less time - providing a significant reduction in operating cost

OLD PROCEDURE

Products Used:

- (20) Aluminium Oxide 800Grit ScrubPADS
- (10) Silicon Carbide 800Grit ScrubPADS
- (250+) LTK Wipers (1 to 2 bags of 150 LTK Wipes)
 - (150) Soaked with DI Water for initial wipe
 - (50+) Soaked with DI Water used while scrubbing
 - (55+) Soaked with IPA for final wipe

Clean Time: 6 Hrs
Technicians: 3 Techs scrubbing (Two at a time, third rotating in)
Recovery Time: 4 Hrs

FOAMTEC INTERNATIONAL WCC ULTRASOLV® CHAMBER CLEANING TECHNIQUE

Vacuum Chamber Products Used:

- (2) HT4536D ScrubPAD, 360 Diamond Grit
- (1) HT4580D ScrubPAD, 800 Diamond Grit
- (1) HT4754 UltraSOLV® Sponge
- (25) HT5790S MiraWIPES®
 - (25) Dampened with IPA used for Final Wipe

Clean Time: 2.5 Hrs
Technicians: One technician completes entire clean
Recovery Time: TBD

FOAMTEC INTERNATIONAL WCC ULTRASOLV[®] CHAMBER CLEANING TECHNIQUE

SEQUENCE OF EVENTS:

- Step 1:** Prep LAM 2300 METAL ETCH Chamber for PM.
- Step 2:** Dampened UltraSOLV[®] Sponge in small container of DI water and wipe out entire chamber. Allow the water to react with deposition and remove the top layer of dep with the UltraSOLV[®] Sponge.
- Step 3:** Rinse out UltraSOLV[®] Sponge as necessary in small container of DI water and continue to wipe chamber until as much deposition as possible has been removed with the UltraSOLV[®] Sponge – approximately 20min.
- Step 4:** Using a light amount of pressure, scrub the chamber and necessary parts associated with the tool with the 360D Grit Diamond ScrubPAD and DI water.
- Step 5:** Unload Diamond ScrubPAD onto UltraSOLV[®] Sponge as ScrubPAD begins to load up with deposition. Repeat as necessary.
- Step 6:** Replace 360 Grit Diamond ScrubPAD as initial ScrubPAD begins to wear.
- Step 7:** Unload UltraSOLV[®] Sponge by placing back in container of DI water to rinse out. Repeat as necessary.
- Step 8:** Repeat steps 4 - 7 until all deposition is removed from entire chamber and associated parts.
- Step 9:** Replace 360 Grit Diamond ScrubPAD with an 800 Grit Diamond ScrubPAD and perform a final scrub of the entire chamber using the same technique as described above with the diamond ScrubPAD and UltraSOLV[®] Sponge.
- Step 10:** Apply a small amount of IPA to the MiraWIPES[®] and wipe out the entire LAM 2300 METAL ETCH Process Chamber and associated parts.

NOTE: STEP 10 IS A VERY CRITICAL STEP TO ENSURE LAM 2300 METAL ETCH CHAMBER RECOVERS FROM PM IN THE MOST EFFICIENT MANNER, MINIMIZING PUMPDOWN TIME AND REDUCING PARTICLES.